

# Results from the NA62 Gigatracker Prototype: a Low Mass and sub-ns Time Resolution Silicon Pixel Detector

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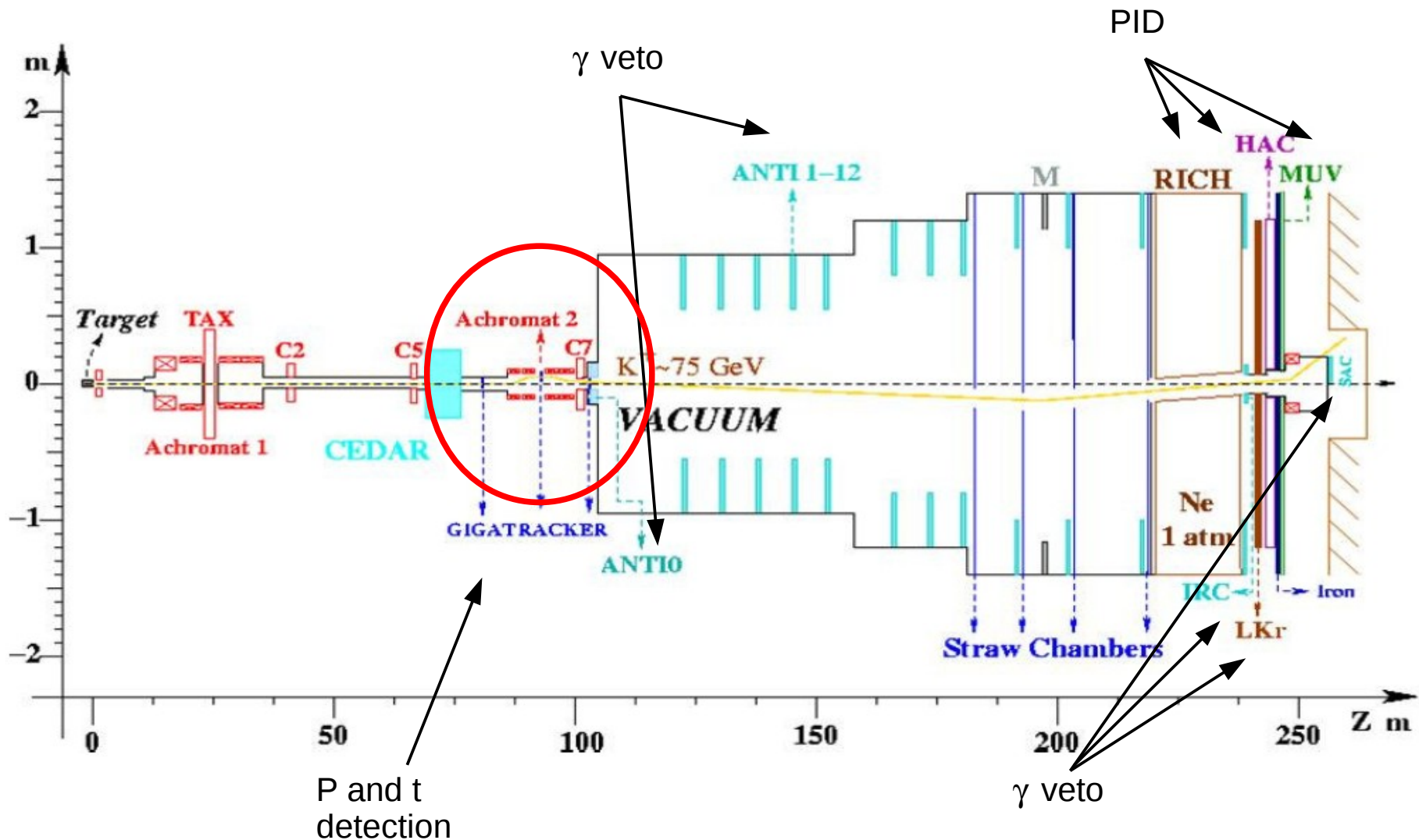
# GTK Working Group

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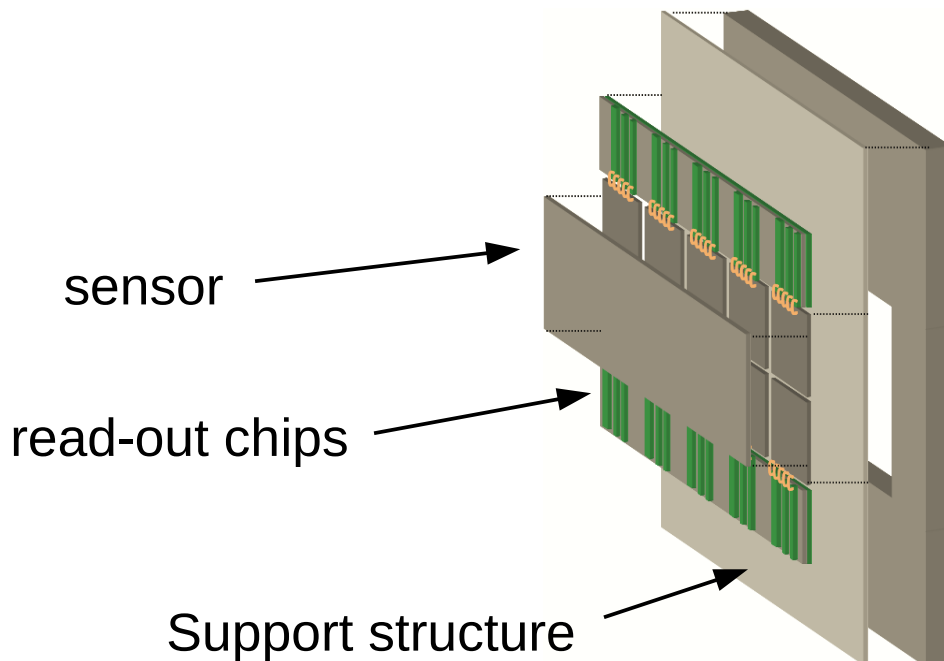
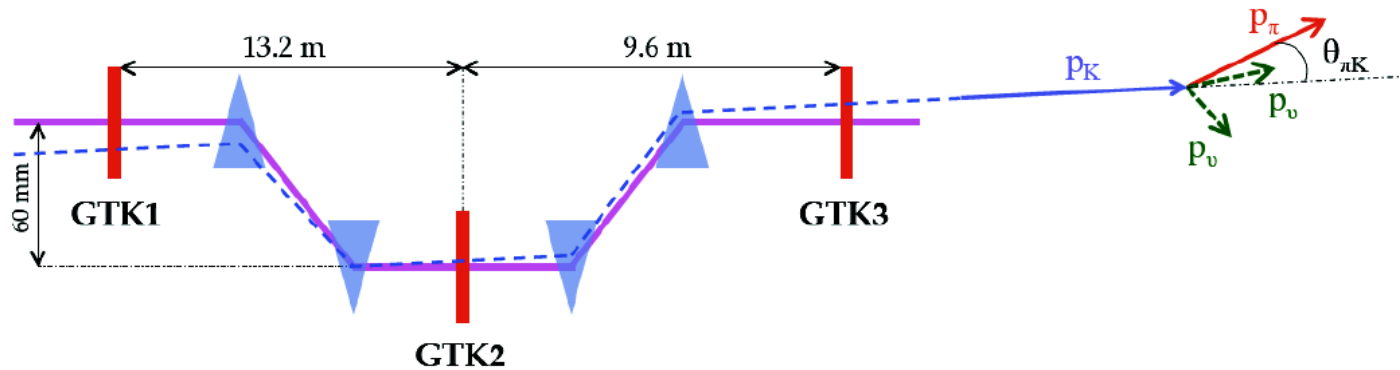
# Context of the Work

- NA62 experiment at the CERN SPS accelerator
- $8 \cdot 10^8$  particles/s, 75 GeV/c
- Ultra-rare decay  $K^+ \rightarrow \pi^+ \nu \bar{\nu}$
- Theoretically very clean:  $|V_{td}|$  CKM (Cabibbo-Kobayashi-Maskawa) matrix can be related to the measured quantity
- It aims to measure 80 events with a branching ratio of  $(8.5 \pm 0.7) \times 10^{-11}$  (SM prediction) and  $\sim 10\%$  background
- Existing measurement based on 7 events (E787/E949):  
 $BR = (1.73^{+1.15}_{-1.05}) \times 10^{-10}$

# Experimental Setup



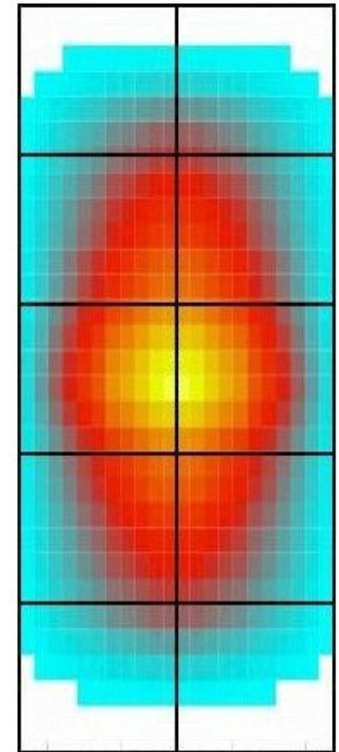
# GTK



- 3 GTK stations
- Single silicon sensor (60mm x 27mm x 200 $\mu$ m)
- 2 x 5 read-out chips
- Support and alignment structure outside the beam area

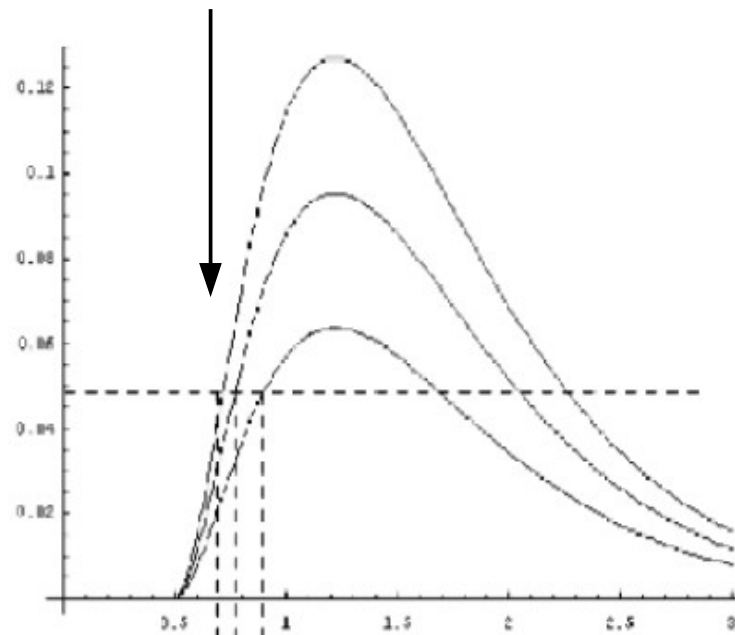
# Read-out Chip Specifications

- $\Delta|P_K|/|P_K| \sim 0.3\%$ ,  $|P_K| = 75 \text{ GeV}$ :  $300\mu\text{m} \times 300\mu\text{m}$  pixels
- Time resolution of 200ps (rms) on the single station (3 stations  $\rightarrow 200/\sqrt{3}=115\text{ps}$ ): jitter, digitization and time walk
- Efficiency  $> 99\%$ : 1fC threshold
- Dead time  $< 1\%$ : max event rate of 150kHz/ch
- Power consumption  $< 2\text{mW/ch}$
- Radiation tolerance: SEU and integral dose deterioration of the sensor



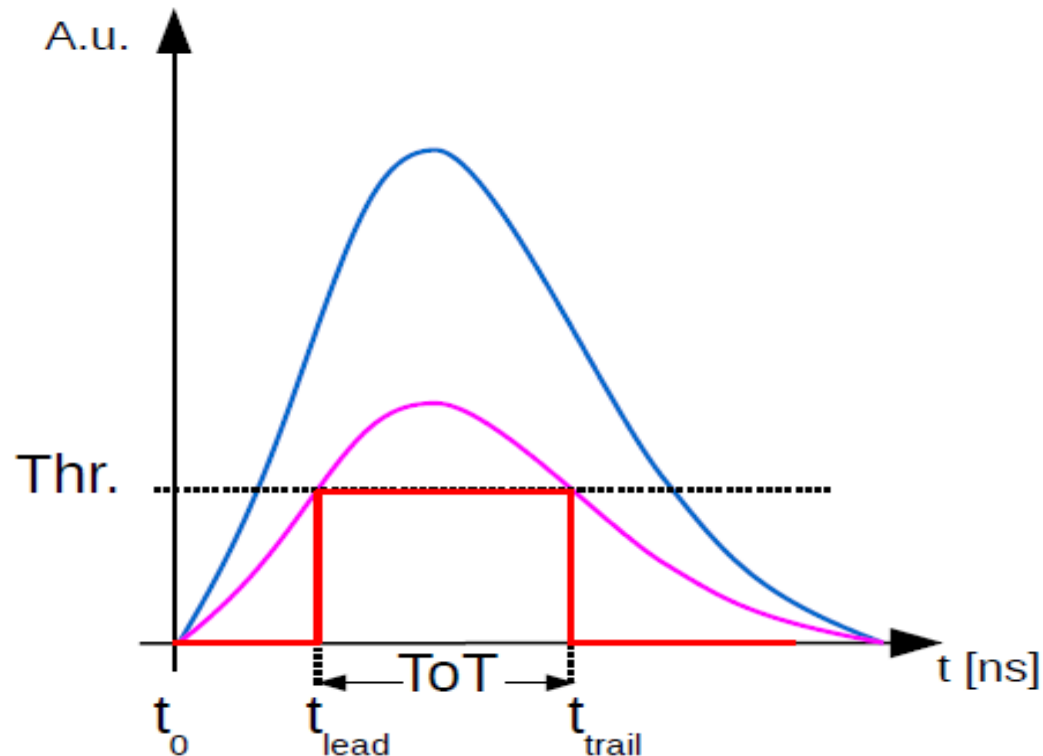
# Time Walk

signals with constant rising time and different amplitudes



time walk error

# Time Over Threshold



Time walk correction is based on an algorithm derived from the correlation between the pulse width and the experienced time walk. In this case two time measurements (rising and falling edge) are performed



# Constant Fraction Discriminator

$$y(t) = \frac{At}{t_P}$$

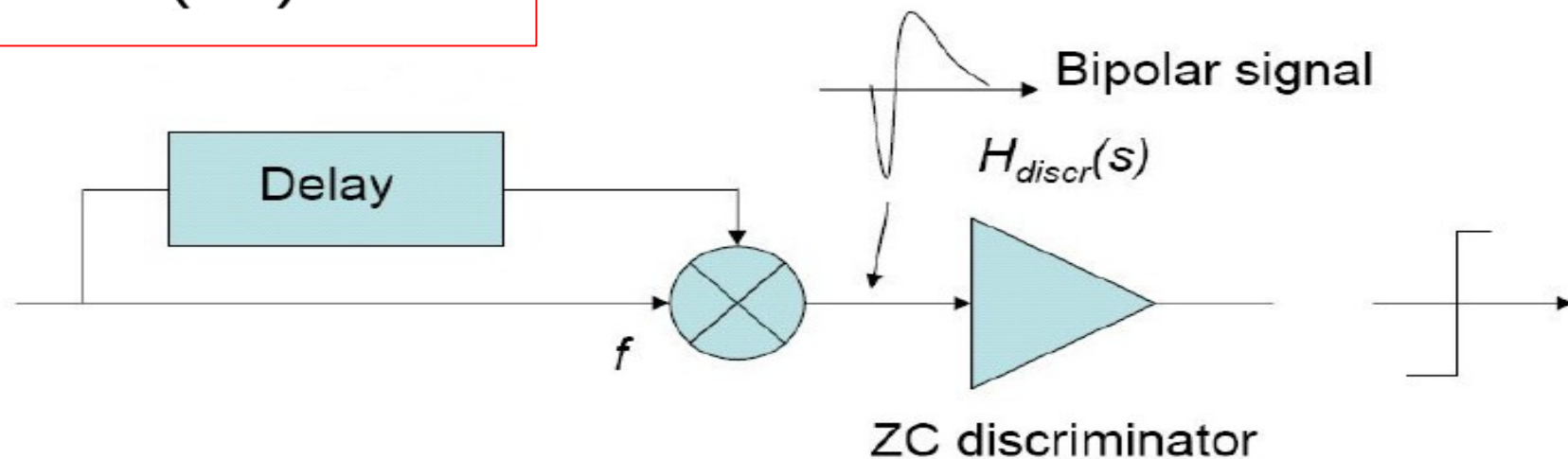
$$y(t-t_d) = fy(t)$$

$$\frac{A(t-t_d)}{t_P} = \frac{fAt}{t_P}$$

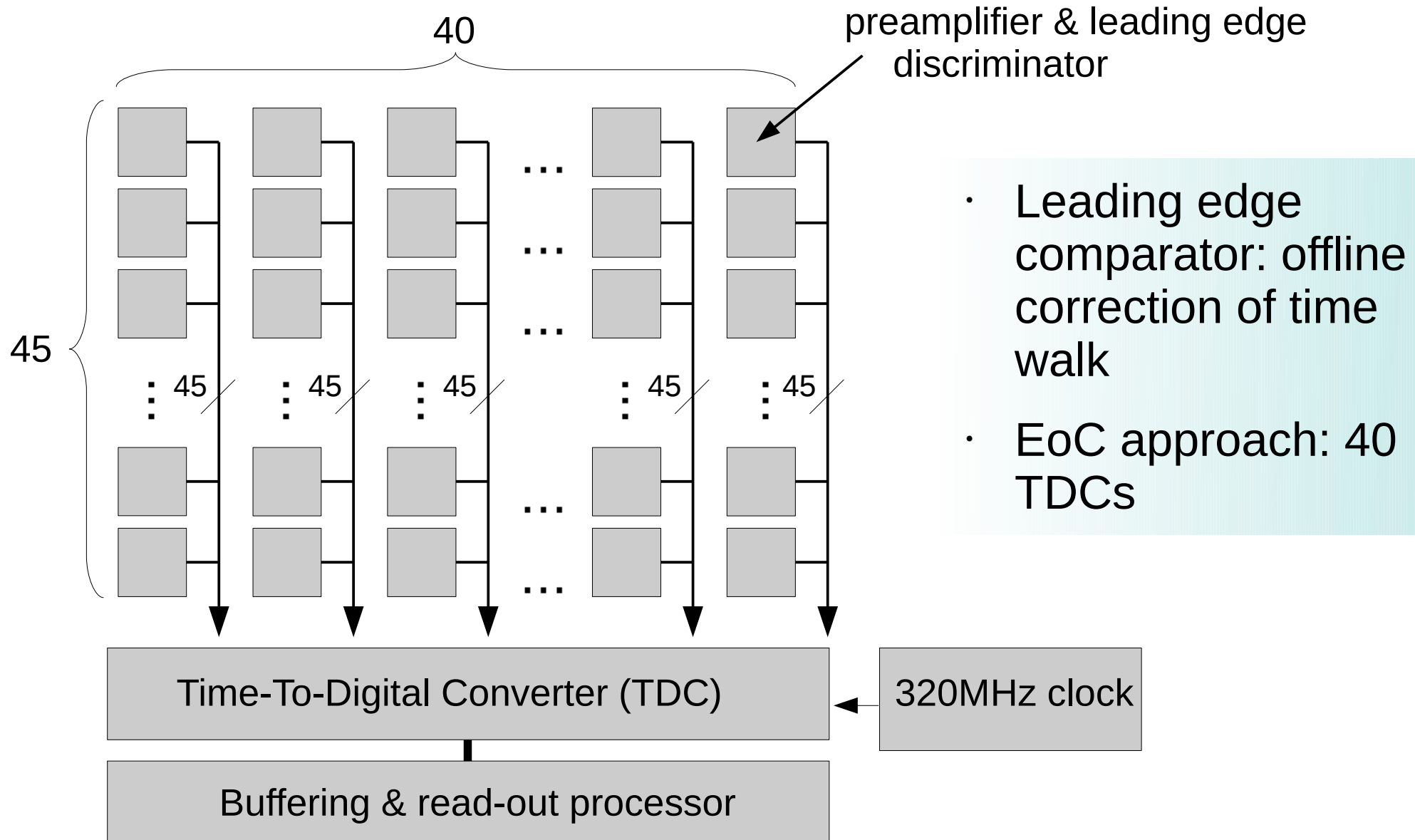
$$t = \frac{t_d}{(1-f)}$$

Approximation: triangular signal

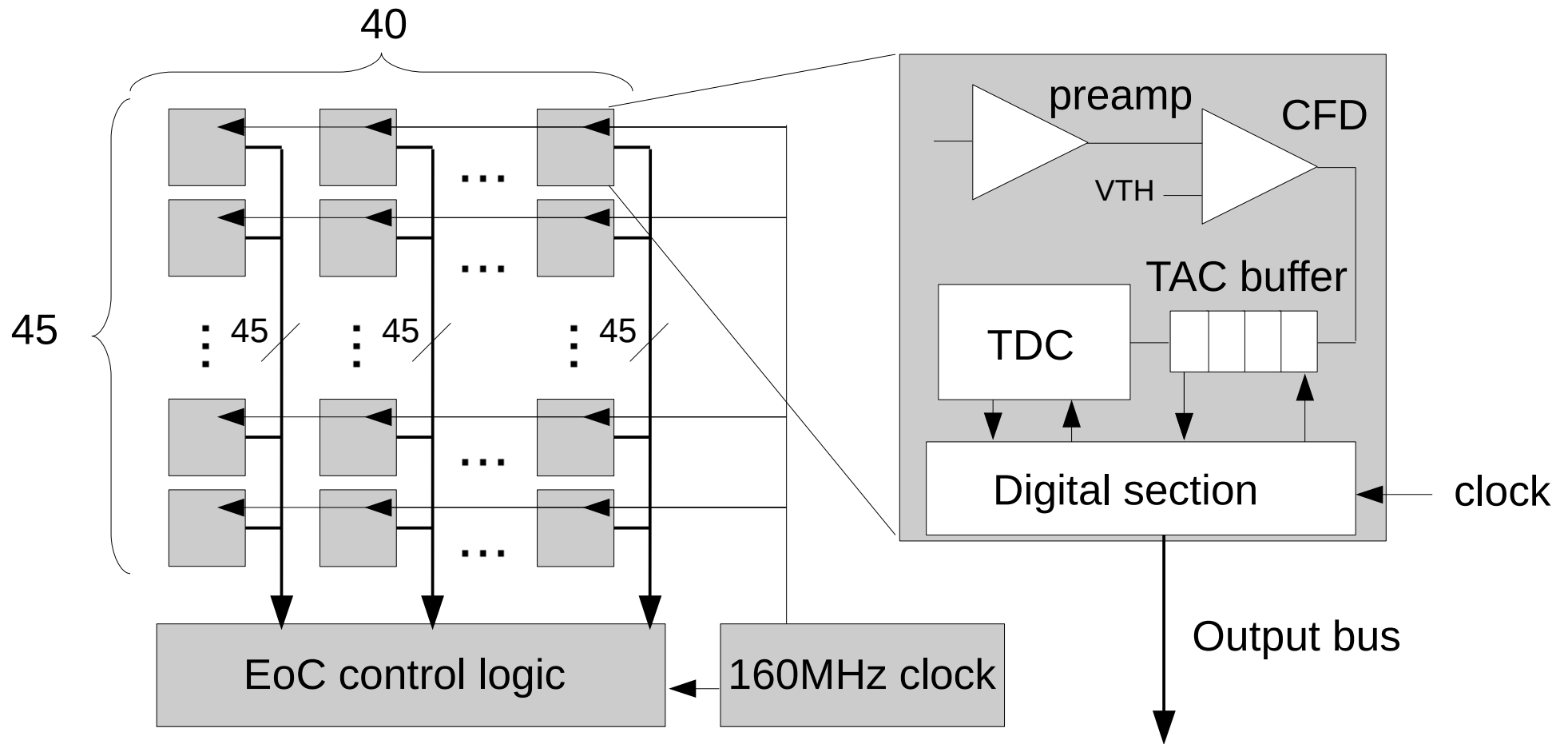
Hypothesis: crossing point always on the linear rising portion of the input signal



# EoC Architecture

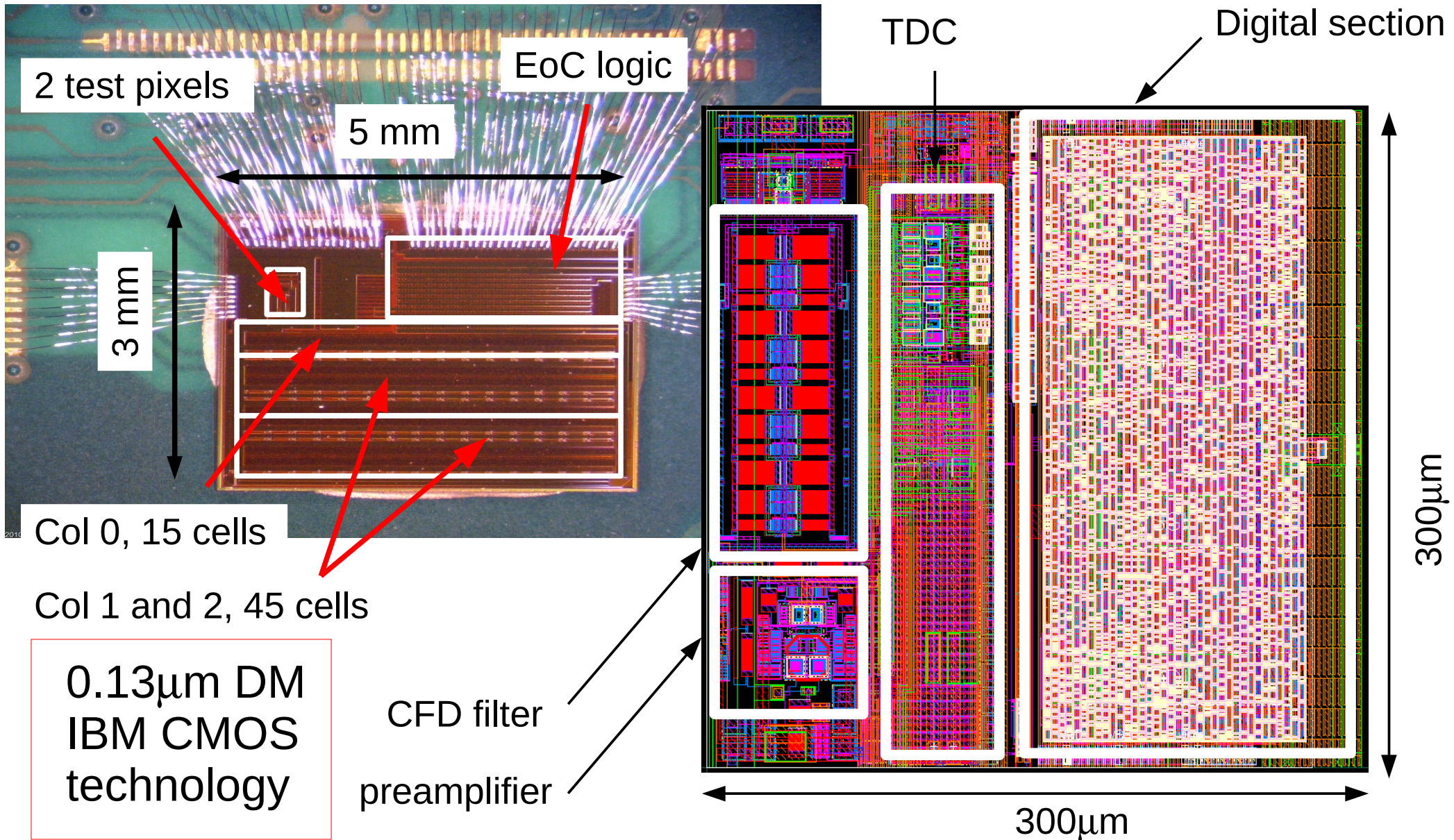


# TDC per Pixel Architecture



- CFD: online correction of time walk
- local approach: 1800 TDCs

# TDC per Pixel Demonstrator



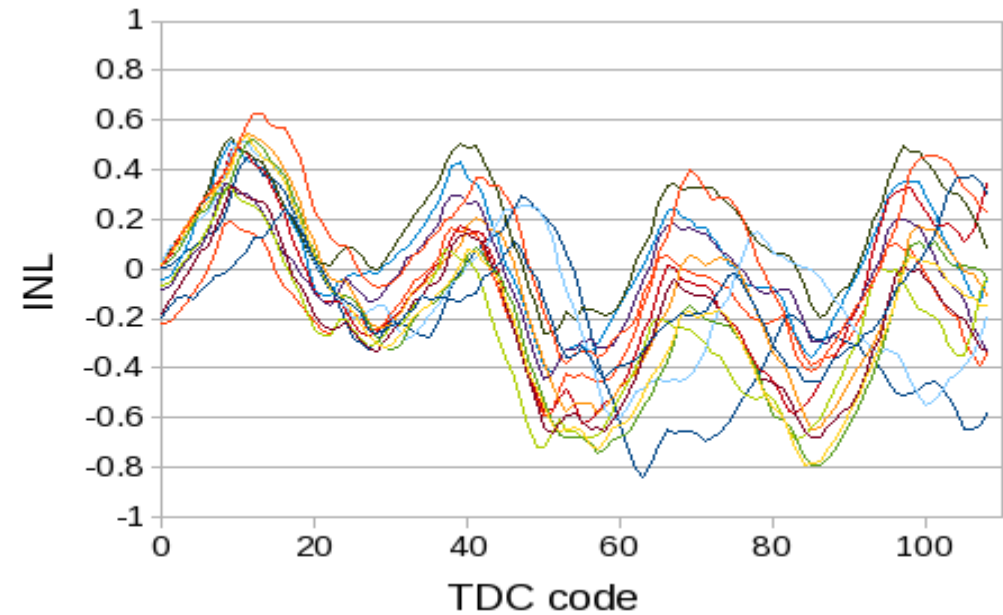
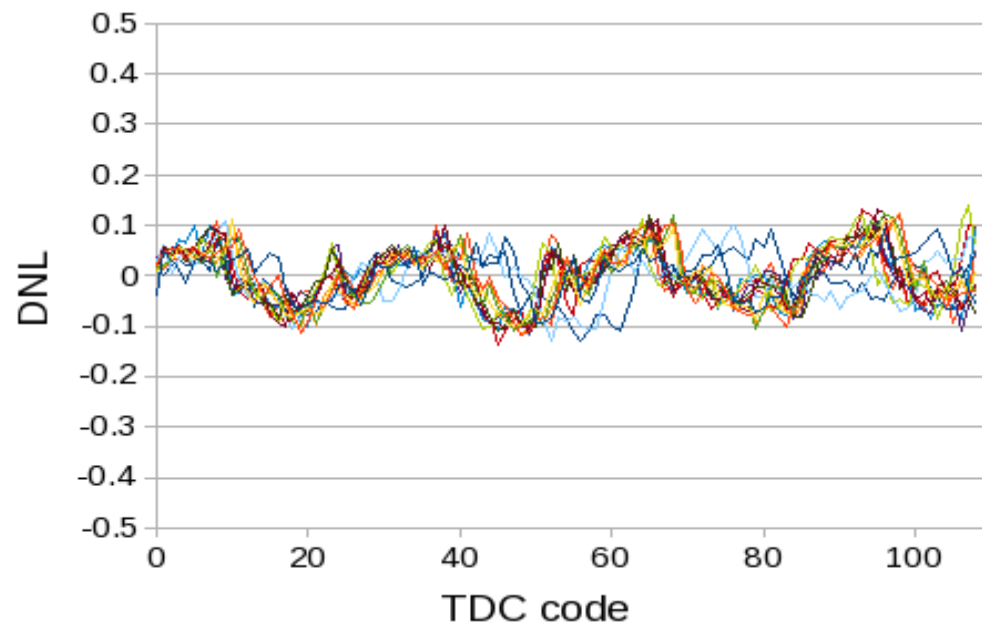
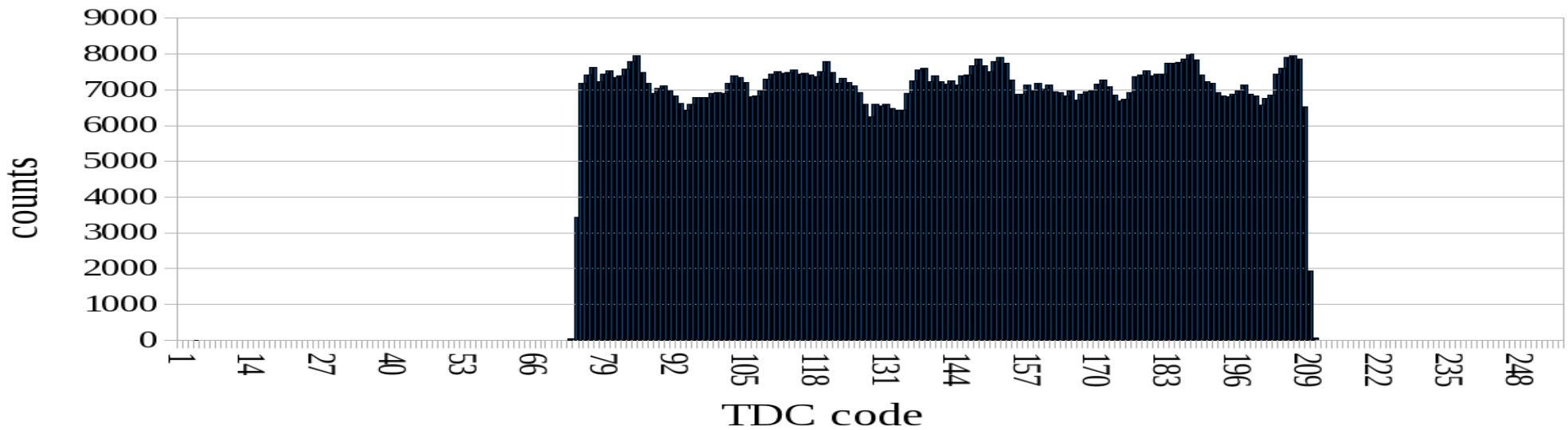
# TDC Linearity (1)

$10^6$  random test pulses to the 7-bits TDC:  $N_{th} = 10^6/2^7$

$$\rightarrow -0.5 < DNL(i) = \frac{N_{exp}(i) - N_{th}(i)}{N_{th}(i)} < 0.5$$

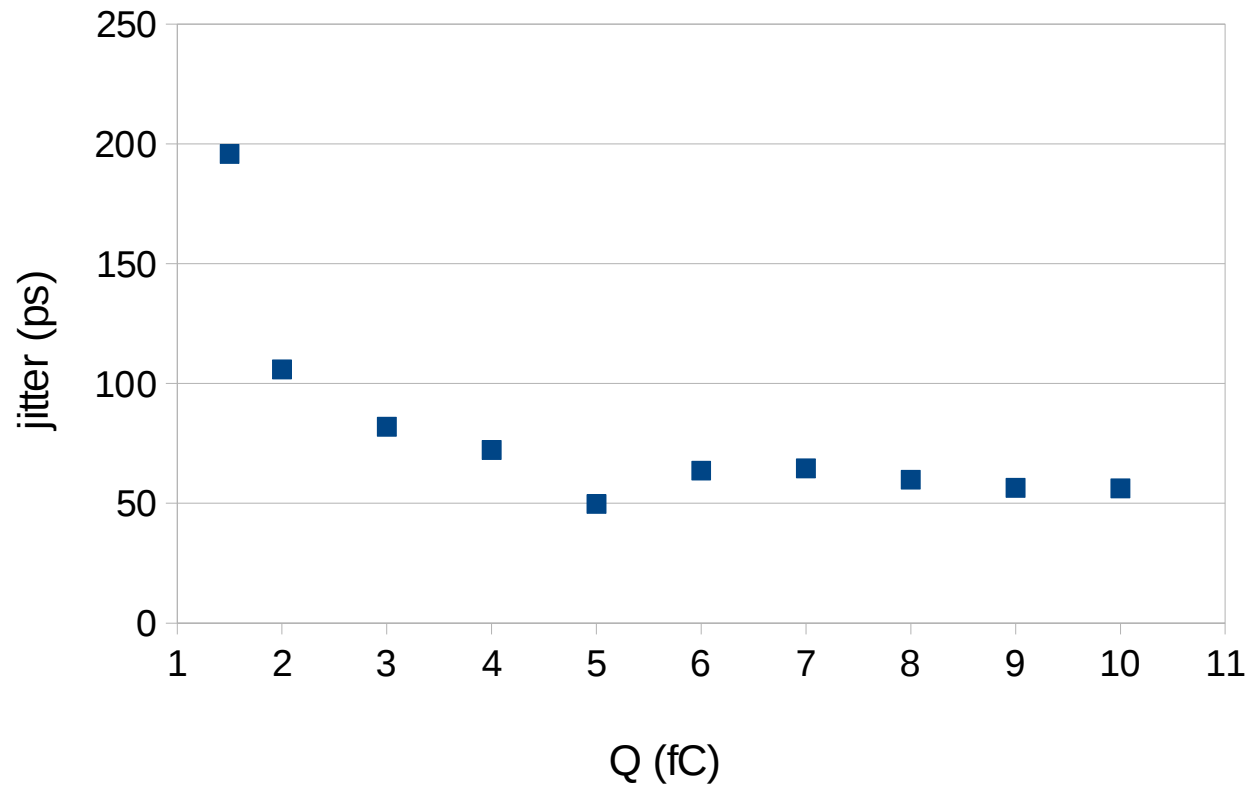
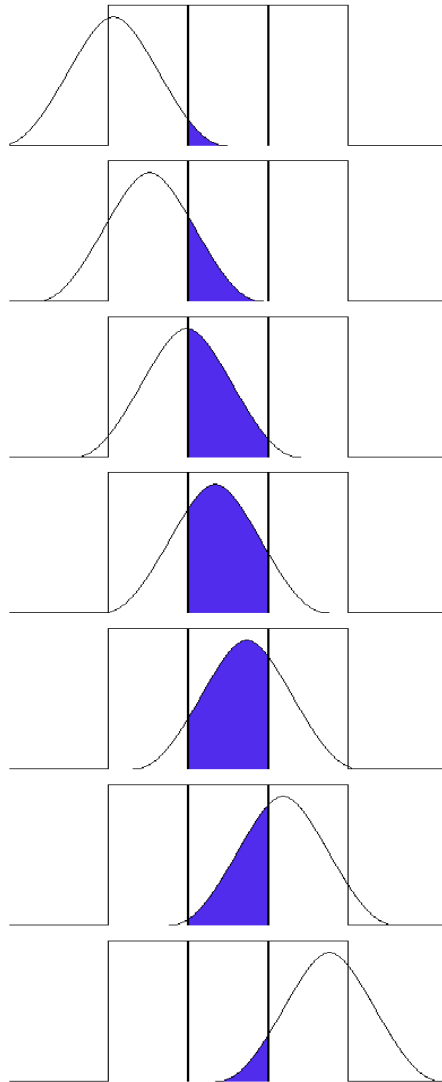
$$\rightarrow -1 < INL(i) = \sum_{i=0}^k DNL(i) < 1$$

# TDC Linearity (2)



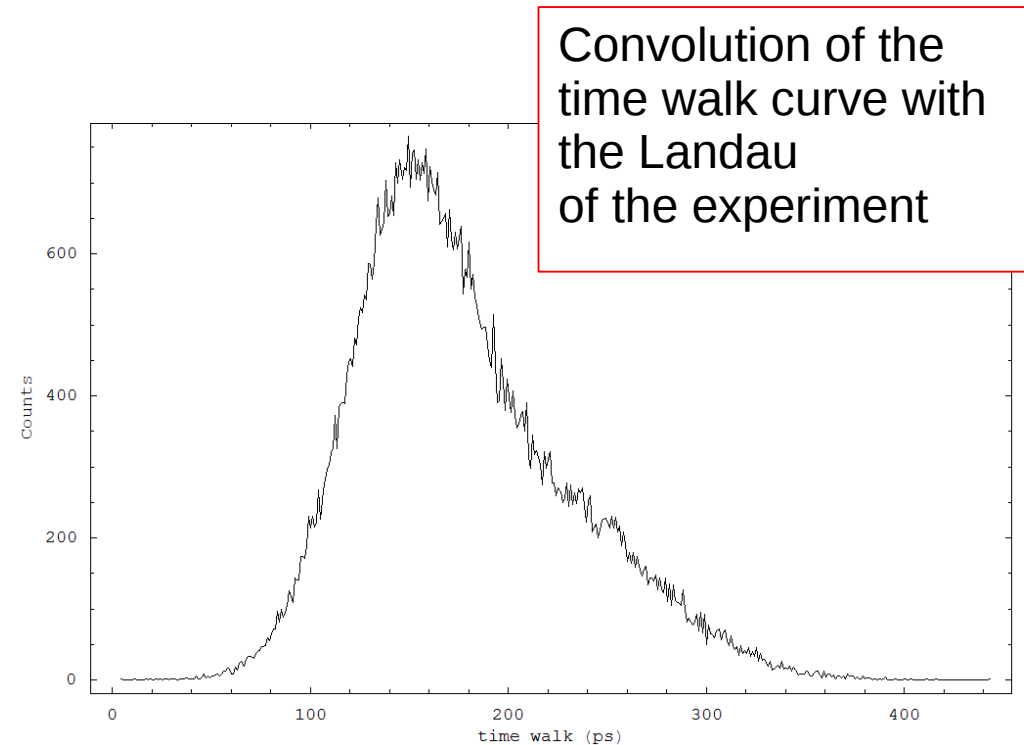
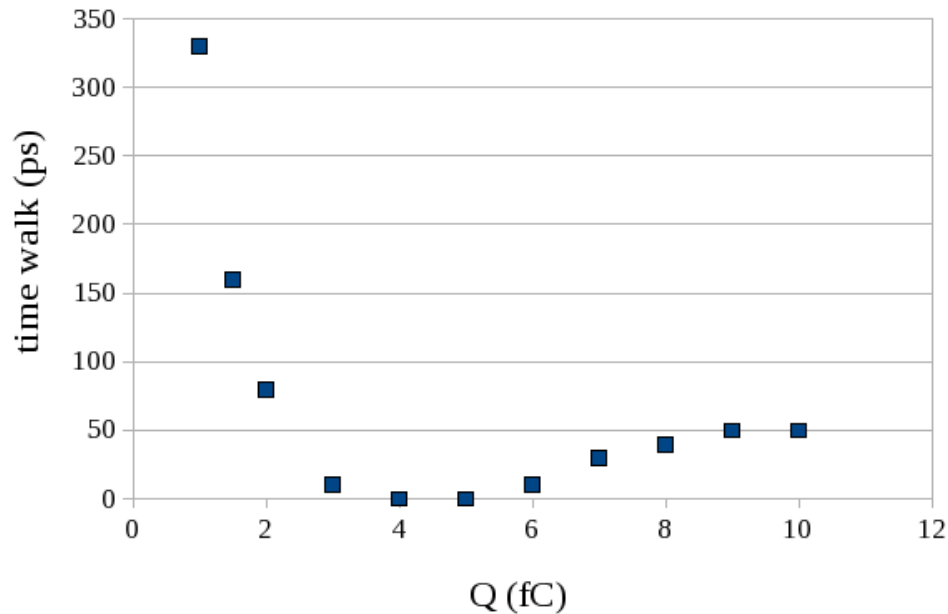
# Jitter

bin i-1 i i+1



Jitter of  $\sim 90$ ps rms at 2.4fC  
measured at the output of matrix  
pixels

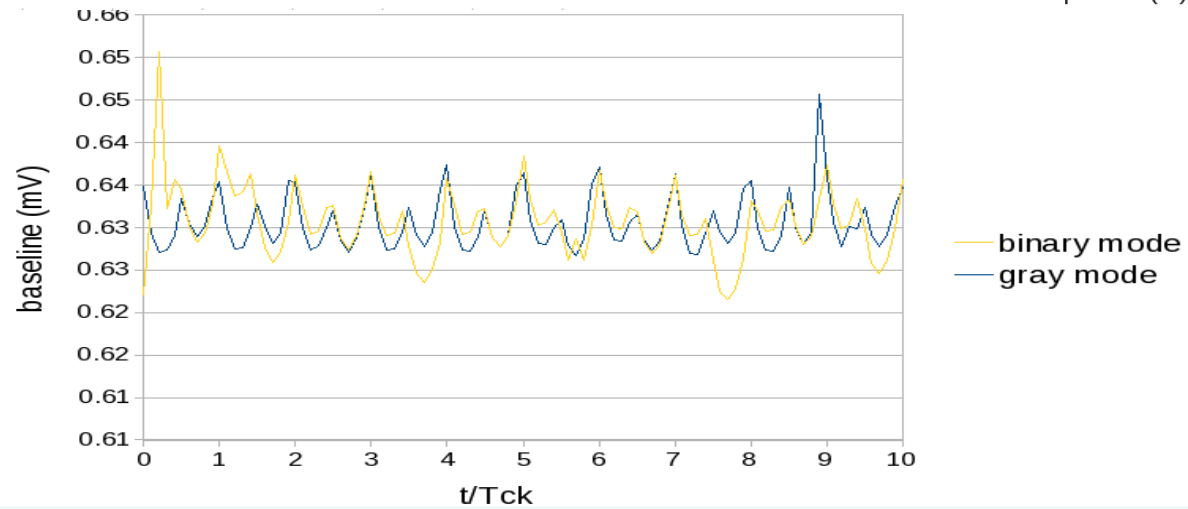
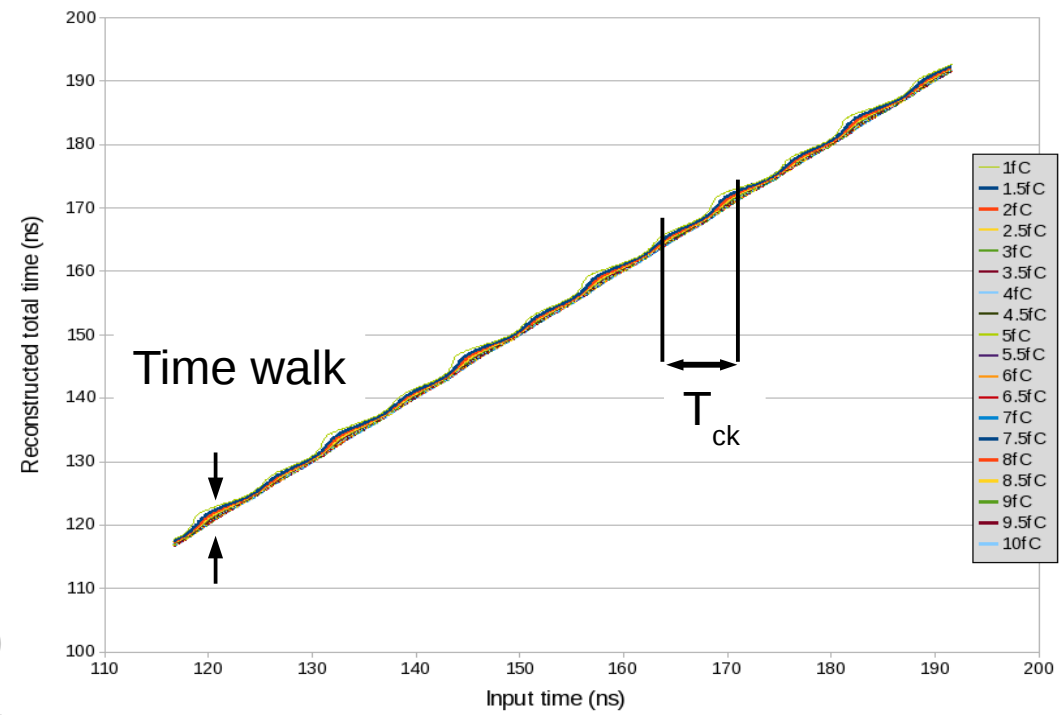
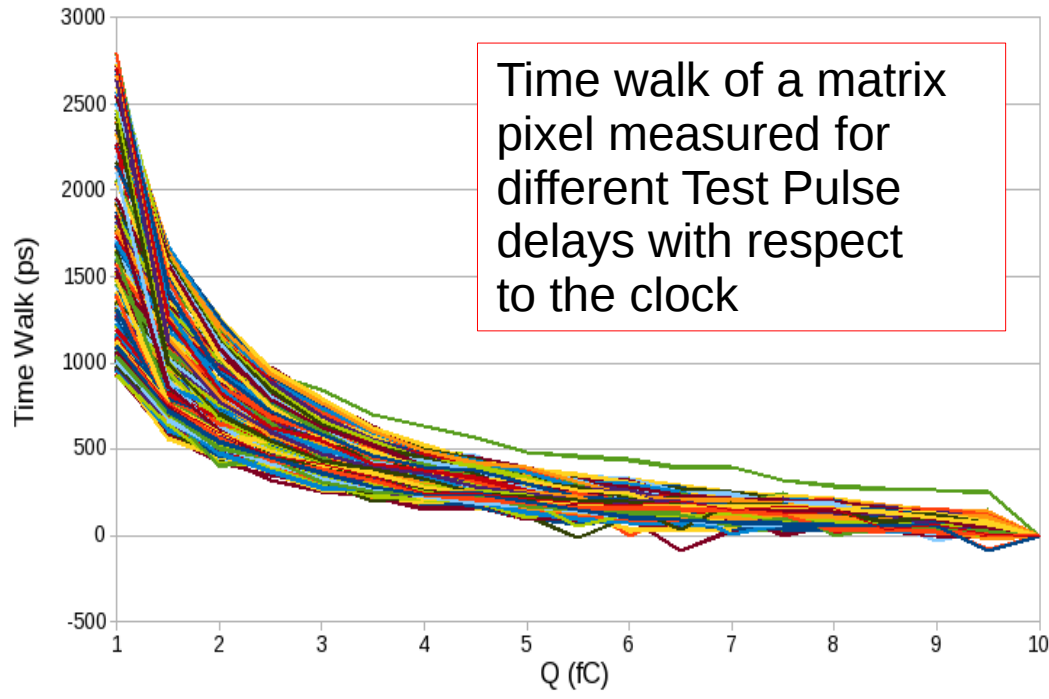
## CFD (1)



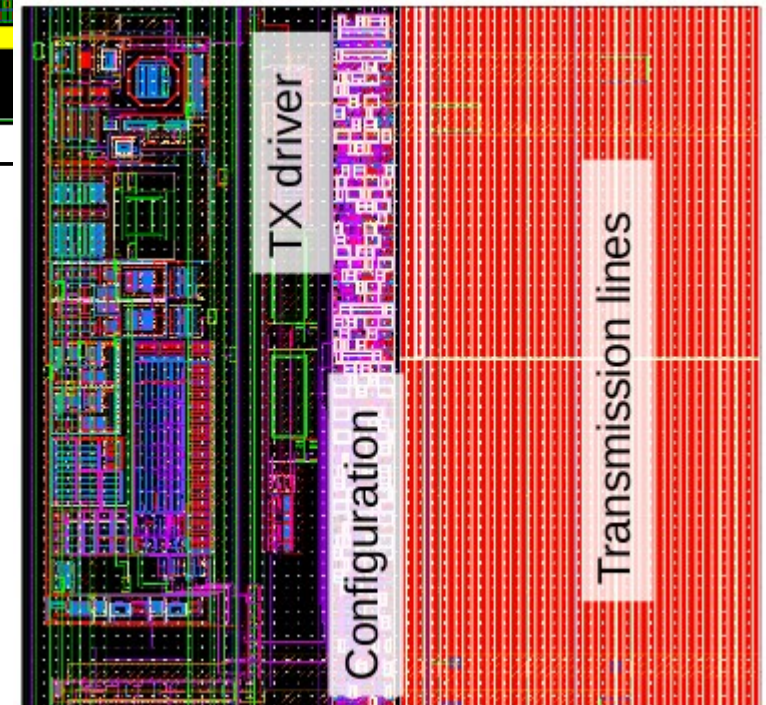
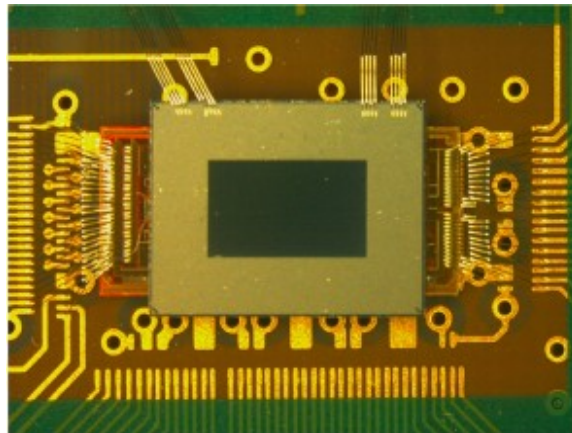
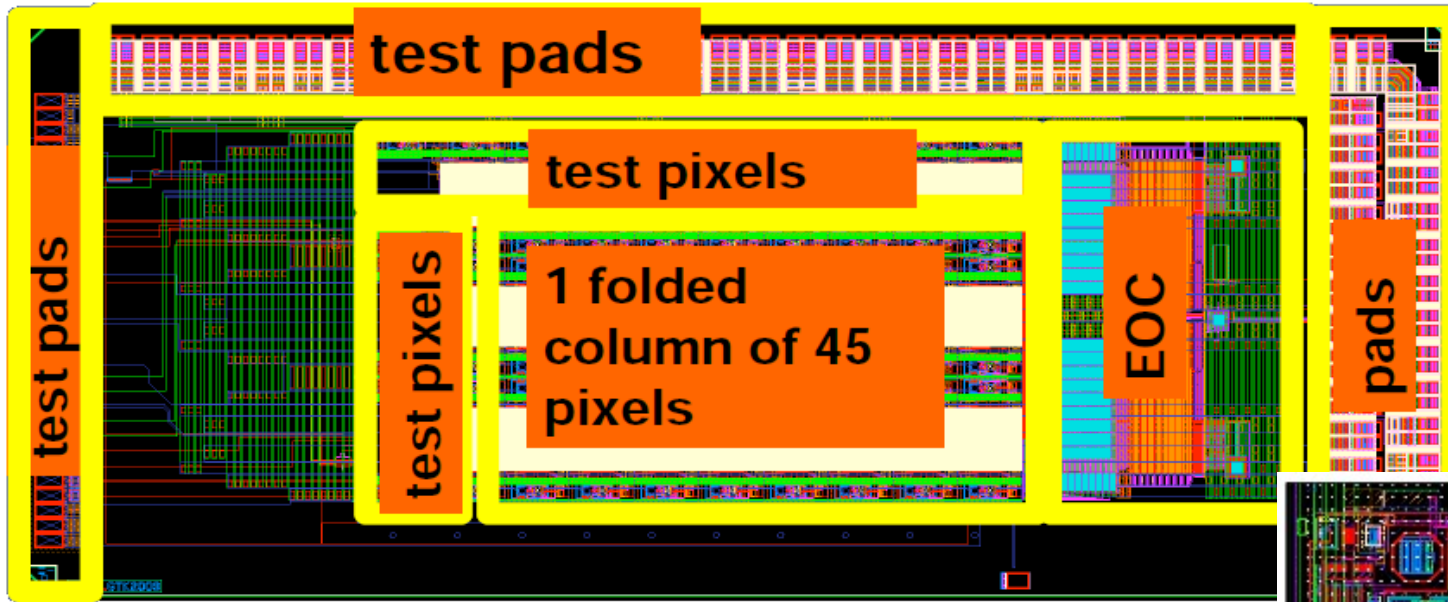
92ps rms time resolution measured at the oscilloscope on the test pixel with the clock switched off



## CFD (2)

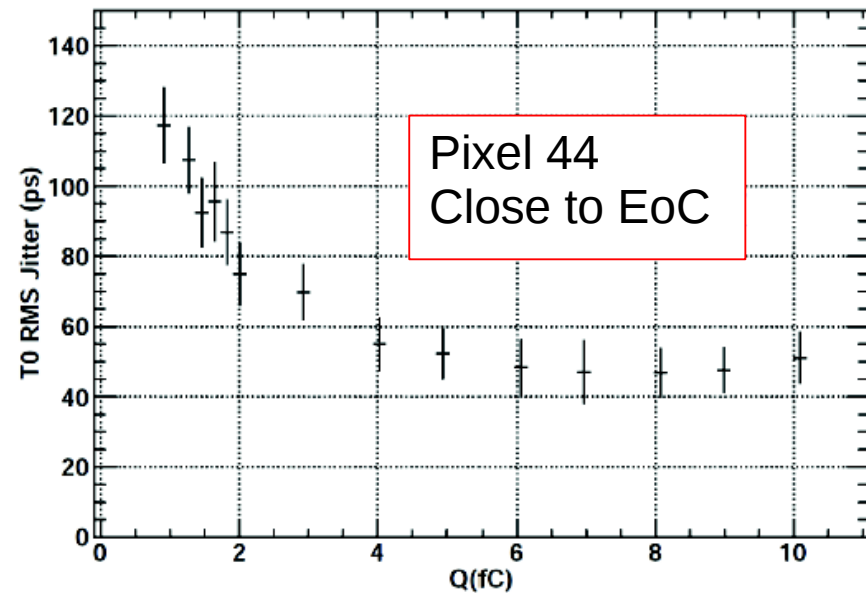
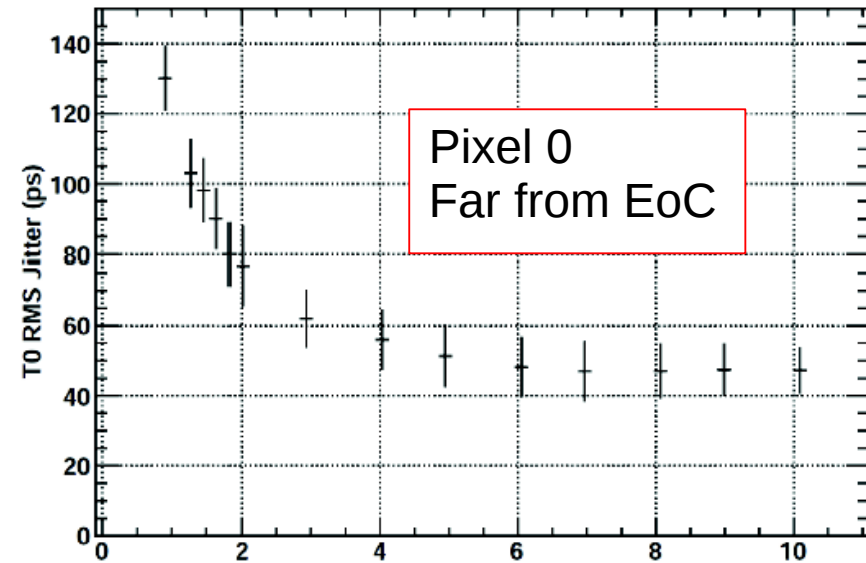


# EoC Demonstrator



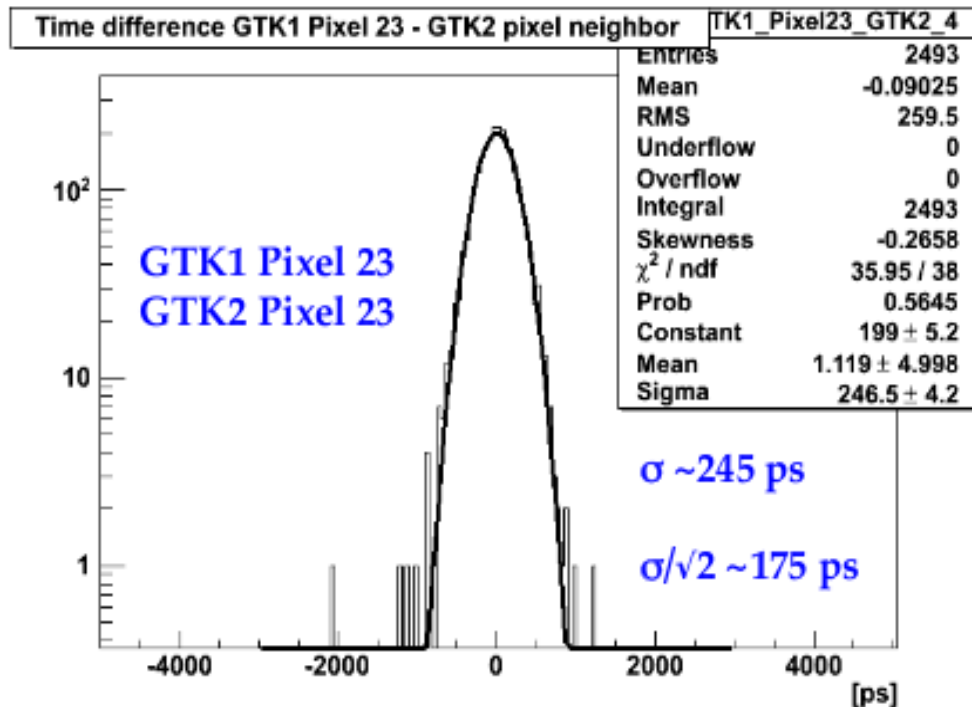
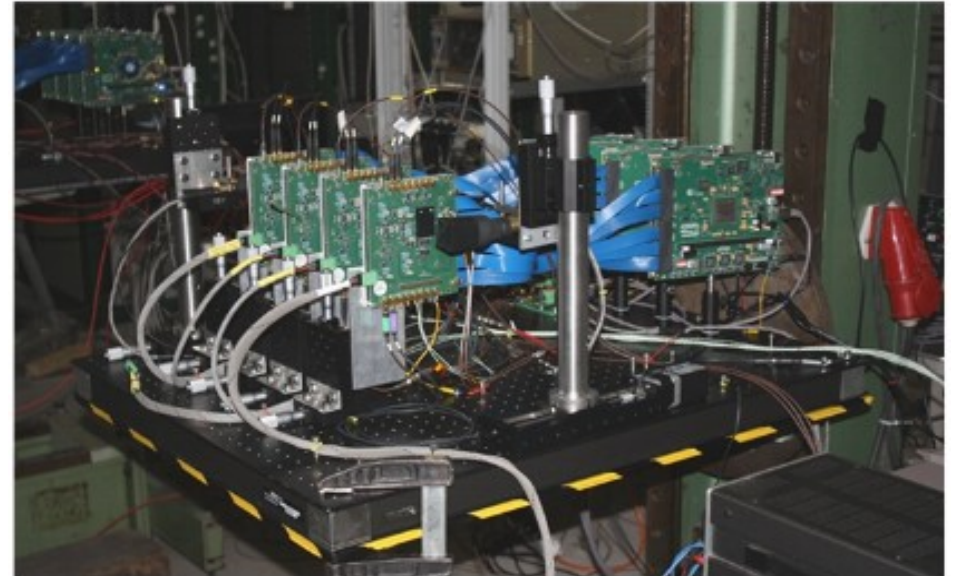
# Laser Test

- Electronic noise from front-end chip  $\sim 180e^-$  (ENC) with sensor
- IR light (1060nm) to reproduce minimum ionizing particles
- Jitter of  $\sim 70ps$  rms at 2.4fC (charge injected at the pixel center)



# Beam Test (1)

- Beam test at CERN T9 (10GeV/c  $\pi^+$  and p)
- 4 consecutive GTK planes
- fast scintillators used as time reference



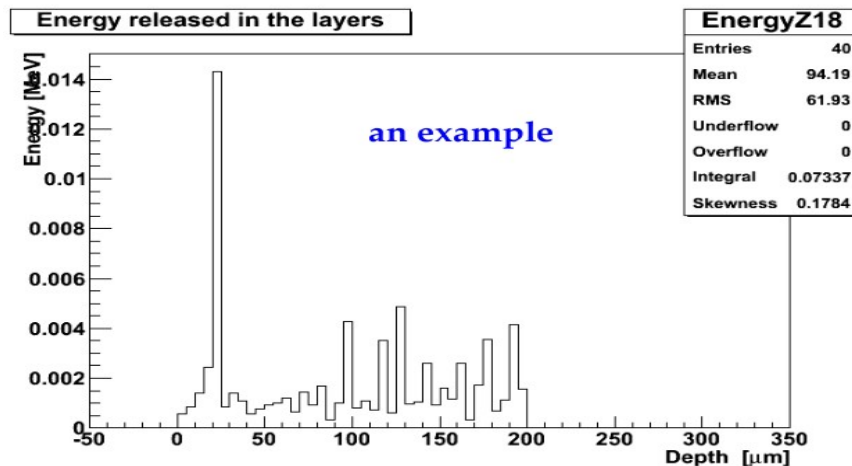
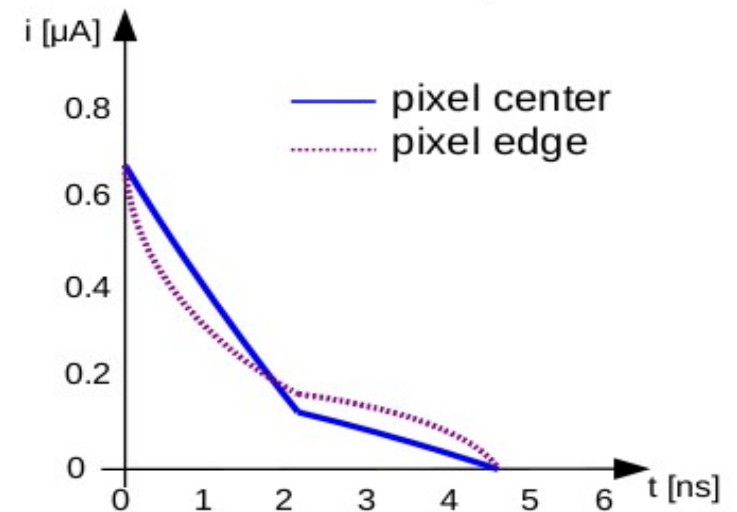
- measured time resolution of  $\sim 175 \text{ ps } \sigma$  at 300V of sensor bias voltage

# Contributions to Timing Error (1)

## Applying to any pixel front-end

- Electronic noise from front-end chip
- Impact position on pixel sensor: geometrical border effects

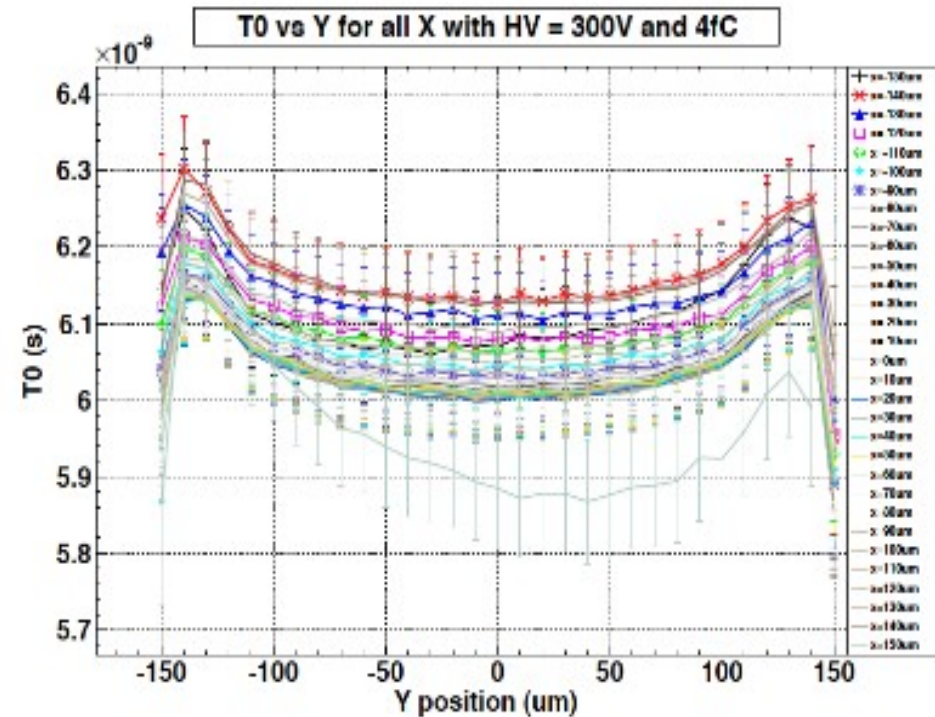
Sensor current pulses



- Energy straggling in the sensor bulk: non uniform charge release along the sensor thickness

# Contributions to Timing Error (2)

- Jitter:  $\sim 70\text{ps rms @ } 2.4\text{fC}$
- $\sim 85\text{ps rms}$  of variation of measured time with impact position inside the pixel (laser measurements)
- $\sim 60\text{ps rms}$  from Geant simulations of charge straggling



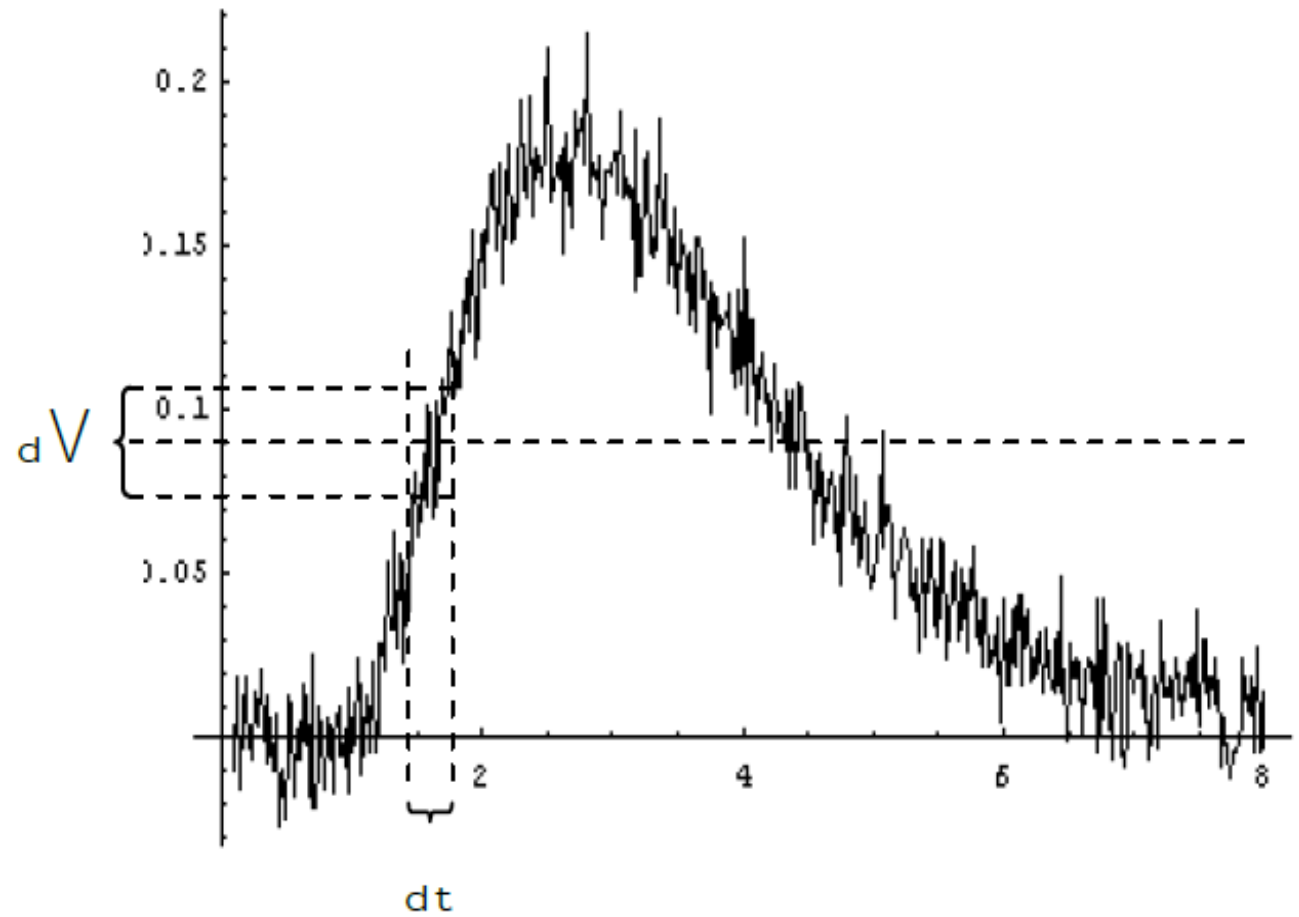
$$\sqrt{70^2 + 85^2 + 60^2} \sim 125\text{ps rms}$$

# Conclusions and Outlook

- Extensive measurements (electrical, laser and beam tests) performed on prototype GTK bump-bonded assemblies
- A time resolution of  $\sim 175$ ps rms has been measured with minimum ionizing particles at 300V with EoC demonstrator
- For the TDC per pixel prototype the CFD has shown an intrinsic resolution of  $\sim 90$ ps rms, while a full system resolution higher than 500ps was measured at the beam test due to identified internal digital noise
- Also due to the tight schedule of the experiment the NA62 collaboration decided to adopt as baseline solution the EoC architecture
- One more prototype of TDC per pixel under development as a possible backup/upgrade solution

# Jitter

$$\sigma_t = \frac{\sigma_n}{dV/dt}$$





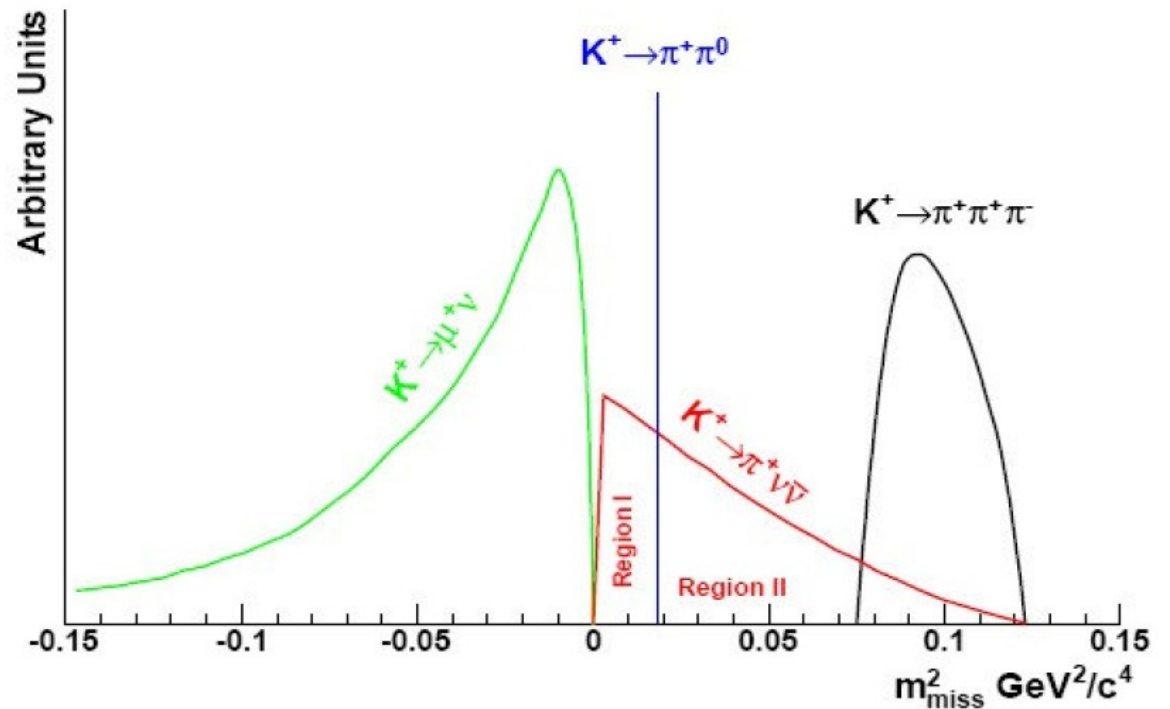
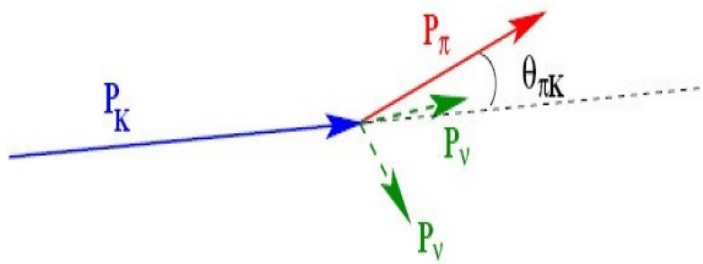
# Physics Motivations

- $$\text{BR}(K^+ \rightarrow \pi^+ \nu \bar{\nu}) = 6r_{K^+} \text{BR}(K^+ \rightarrow \pi^0 e^+ \nu) \frac{|G_I|}{G_F^2 |V_{us}|^2}$$
- $$G_I = \frac{\alpha G_F}{2\pi \sin^2 \Theta_W} [V_{ts}^* V_{td} X(x_t) + V_{cs}^* V_{cd} X(x_{NL})]$$
- $V_{td}$  theoretical error of  $\sim 5-7\%$

# Background Rejection (1)

Decay mode	BR	Background rejection
$K^+ \rightarrow \mu^+ \nu$	63%	$\mu$ PID, kinematics
$K^+ \rightarrow \pi^+ \pi^0$	21%	$\gamma$ veto, kinematics
$K^+ \rightarrow \pi^+ \pi^+ \pi^-$	6%	charged particle veto, kinematics
$K^+ \rightarrow \pi^+ \pi^0 \pi^0$	2%	$\gamma$ veto, kinematics
$K^+ \rightarrow \pi^0 \mu^+ \nu$	3%	$\gamma$ veto, $\mu$ PID
$K^+ \rightarrow \pi^0 e^+ \nu$	5%	$\gamma$ veto, E/p

# Background Rejection (2)



- Region I:  $0 < m_{\text{miss}}^2 < m_{\pi^0}^2 - (\Delta m)^2$
- Region II:  $m_{\pi^0}^2 + (\Delta m)^2 < m_{\text{miss}}^2 < \min[m_{\text{miss}}^2 (\pi^+ \pi^+ \pi^-)]$

# Background Rejection (3)

$$m_{\text{miss}}^2 = m_K^2 \left(1 - \frac{|\mathbf{P}_\pi|}{|\mathbf{P}_K|}\right) + m_\pi^2 \left(1 - \frac{|\mathbf{P}_K|}{|\mathbf{P}_\pi|}\right) - |\mathbf{P}_K| |\mathbf{P}_\pi| \theta_{\pi K}^2$$

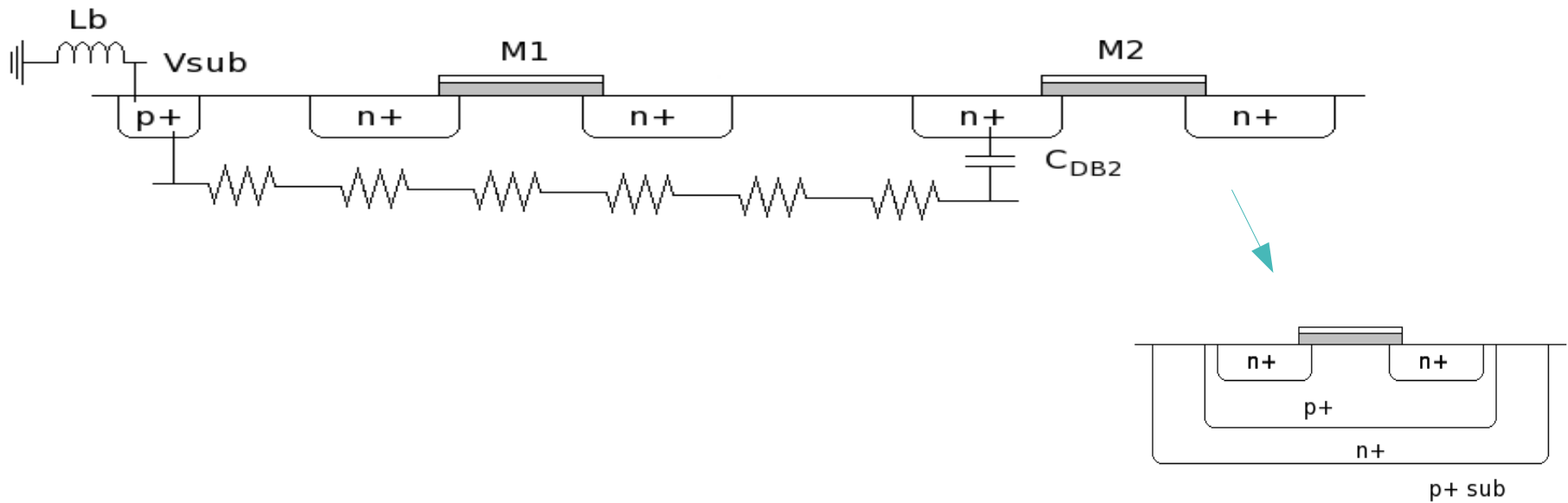
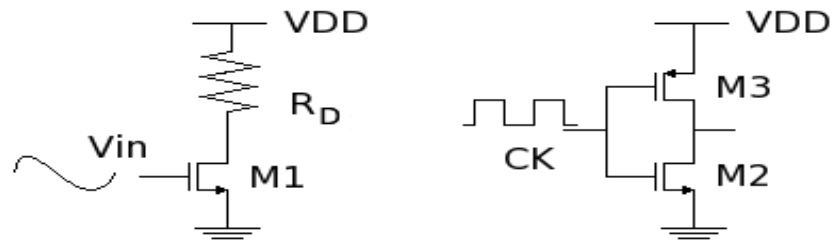
- $\Delta |\mathbf{P}_K| / |\mathbf{P}_K| \sim 0.3\%$ ,  $|\mathbf{P}_K| = 75 \text{ GeV}$
- $\Delta |\mathbf{P}_\pi| / |\mathbf{P}_\pi| \sim 1\%$  at 30 GeV
- $\Delta \theta_{\pi K} \sim 50\text{-}60 \text{ } \mu\text{rad}$
- $(\Delta m_{\text{miss}}^2) \sim 8 \times 10^{-3} \text{ GeV}^2/c^4$



## GTK

- 300 $\mu\text{m}$  x 300 $\mu\text{m}$  pixel
- $\sim 100 \text{ ps}$  time resolution due to high particle rate (60MHz/cm<sup>2</sup>)

# Substrate Noise



# TDC

